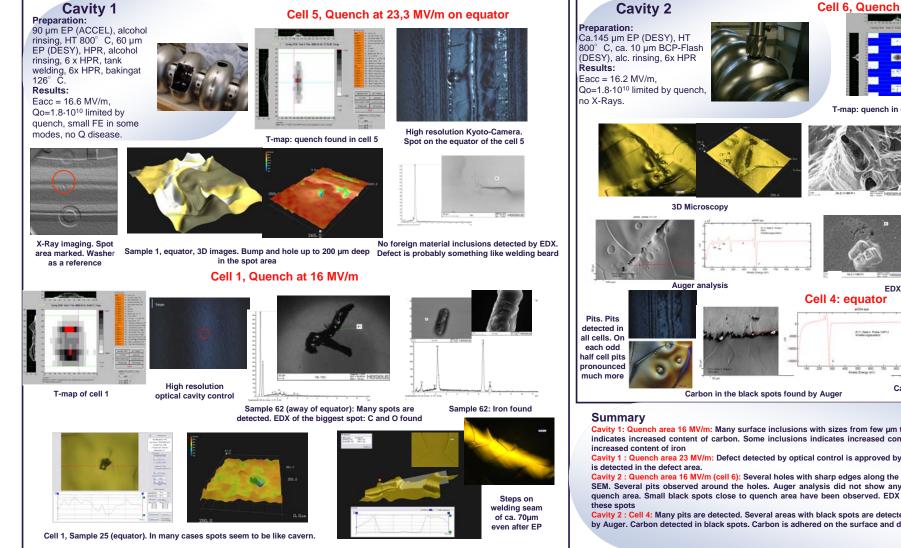


Surface Investigation of Samples Extracted from Prototype Cavities for **European XFEL**

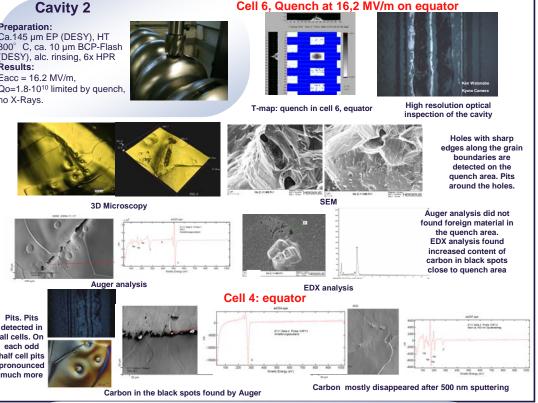
W. Singer, X. Singer, A. Ermakov, K. Twarowski, S. Aderhold (DESY, Germany); F. Schölz (W.C. Heraeus, Germany); P. Michelato, L. Monaco (INFN, Italy)

Abstract

Few cavities of the 4th and 6th cavity generation treated accordingly the XFEL recipe have shown performance of ca. 15-17 MV/m caused by thermal break down without field emission. The T-map analysis detected the quench areas mainly close to the equator. Optical control by high resolution camera and non-destructive X-Ray radiography have been applied and allowed to monitor the defects in some cases with good correlation to T-map observation. In order to get more detailed information of defects some samples have been extracted from cavity and investigated by light microscope, 3D- microscope, SEM, EDX and Auger spectroscopy.



Deutsches Elektronen-Synchrotron DESY Helmholtz Association of German Research Centres 22603 Hamburg, Germany www.xfel.eu



Cavity 1: Quench area 16 MV/m: Many surface inclusions with sizes from few um to hundreds of um detected by SEM. Most inclusions indicates increased content of carbon. Some inclusions indicates increased content of oxygen and carbon. One inclusion indicates

Cavity 1 : Quench area 23 MV/m: Defect detected by optical control is approved by SEM, 3d- and light microscopes. No foreign material

Cavity 2 : Quench area 16 MV/m (cell 6): Several holes with sharp edges along the grain boundaries are detected on the quench area by SEM. Several pits observed around the holes. Auger analysis did not show any indication of the foreign material inclusions in the quench area. Small black spots close to quench area have been observed. EDX analysis has shown increased content of carbon in

Cavity 2 : Cell 4: Many pits are detected. Several areas with black spots are detected close to equator. Two areas have been analyzed by Auger. Carbon detected in black spots. Carbon is adhered on the surface and disappeared after ca. 500 nm sputtering.

